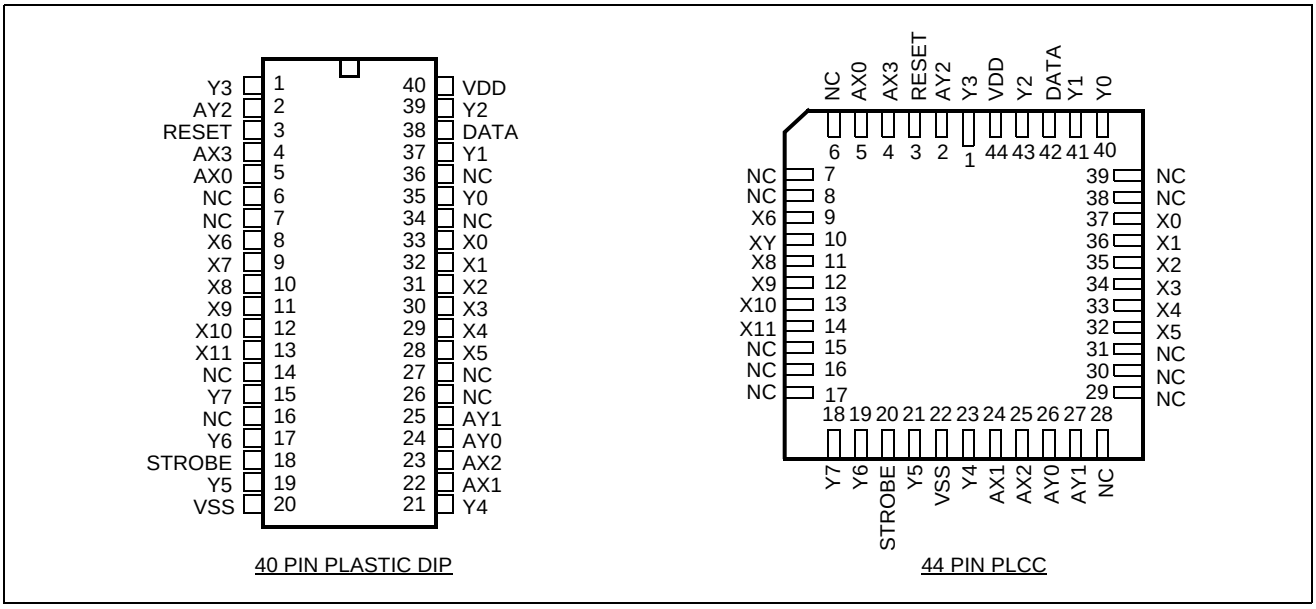


Figure 2 - Pin Connections

Change Summary

Changes from the August 2005 issue to the September 2011 issue.

Page	Item	Change
1	Ordering Information	Removed leaded packages as per PCN notice.

Pin Description

Pin #		Name	Description
PDIP	PLCC		
1	1	Y3	**Y3 Analog (Input/Output):** this is connected to the Y3 column of the switch array.
2	2	AY2	**Y2 Address Line (Input)**.
3	3	RESET	**Master RESET (Input):** this is used to turn off all switches. Active High.
4,5	4,5	AX3,AX0	**X3 and X0 Address Lines (Inputs)**.
6,7	6-8	NC	**No Connection.**
8-13	9-14	X6-X11	**X6-X11 Analog (Inputs/Outputs):** these are connected to the X6-X11 rows of the switch array.
14	15-17	NC	**No Connection.**
15	18	Y7	**Y7 Analog (Input/Output):** this is connected to the Y7 column of the switch array.
16	-	NC	**No Connection.**
17	19	Y6	**Y6 Analog (Input/Output):** this is connected to the Y6 column of the switch array.

Pin Description

Pin #		Name	Description
PDIP	PLCC		
18	20	STROBE	**STROBE (Input)**: enables function selected by address and data. Address must be stable before STROBE goes high and DATA must be stable on the falling edge of the STROBE. Active High.
19	21	Y5	**Y5 Analog (Input/Output):** this is connected to the Y5 column of the switch array.
20	22	V_{SS}	**Ground Reference.**
21	23	Y4	**Y4 Analog (Input/Output):** this is connected to the Y4 column of the switch array.
22, 23	24,25	AX1,AX2	**X1 and X2 Address Lines (Inputs)**.
24, 25	26,27	AY0,AY1	**Y0 and Y1 Address Lines (Inputs)**.
26, 27	28-31	NC	**No Connection.**
28 - 33	32-37	X5-X0	**X5-X0 Analog (Inputs/Outputs):** these are connected to the X5-X0 rows of the switch array.
34	38,39	NC	**No Connection.**
35	40	Y0	**Y0 Analog (Input/Output)**: this is connected to the Y0 column of the switch array.
36	-	NC	**No Connection.**
37	41	Y1	**Y1 Analog (Input/Output)**: this is connected to the Y1 column of the switch array.
38	42	DATA	**DATA (Input)**: a logic high input will turn on the selected switch and a logic low will turn off the selected switch. Active High.
39	43	Y2	**Y2 Analog (Input/Output)**: this is connected to the Y2 column of the switch array.
40	44	V_{DD}	**Positive Power Supply.**

Functional Description

The MT093 is an analog switch matrix with an array size of 8 x 12. The switch array is arranged such that there are 8 columns by 12 rows. The columns are referred to as the Y input/output lines and the rows are the X input/output lines. The crosspoint analog switch array will interconnect any X line with any Y line when turned on and provide a high degree of isolation when turned off. The control memory consists of a 96 bit write only RAM in which the bits are selected by the address input lines (AY0-AY2, AX0-AX3). Data is presented to the memory on the DATA input line. Data is asynchronously written into memory whenever the STROBE input is high and is latched on the falling edge of STROBE. A logical “1” written into a memory cell turns the corresponding crosspoint switch on and a logical “0” turns the crosspoint off. Only the crosspoint switches corresponding to the addressed memory location are altered when data is written into memory. The remaining switches retain their previous states. Any combination of X and Y lines can be interconnected by establishing appropriate patterns in the control memory. A logical “1” on the RESET input line will asynchronously return all memory locations to logical “0” turning off all crosspoint switches.

Address Decode

The seven address lines along with the STROBE input are logically ANDed to form an enable signal for the resettable transparent latches. The DATA input is buffered and is used as the input to all latches. To write to a location, RESET must be low while the address and data lines are set up. Then the STROBE input is set high and then low causing the data to be latched. The data can be changed while STROBE is high, however, the corresponding switch will turn on and off in accordance with the data. Data must be stable on the falling edge of STROBE in order for correct data to be written to the latch.

Absolute Maximum Ratings* - Voltages are with respect to V_{SS} unless otherwise stated.

	Parameter	Symbol	Min.	Max.	Units
1	Supply Voltage	V_{DD} V_{SS}	-0.3 -0.3	16.0 V_{DD}+0.3	V V
2	Analog Input Voltage	V_{INA}	-0.3	V_{DD}+0.3	V
3	Digital Input Voltage	V_{IN}	V_{SS}-0.3	V_{DD}+0.3	V
4	Current on any I/O Pin	I		±15	mA
5	Storage Temperature	T_S	-65	+150	°C
6	Package Power Dissipation PLASTIC DIP	P_D		0.6	W

* Exceeding these values may cause permanent damage. Functional operation under these conditions is not implied.

Recommended Operating Conditions - Voltages are with respect to V_{SS} unless otherwise stated.

	Characteristics	Sym.	Min.	Typ.	Max.	Units	Test Conditions
1	Operating Temperature	T_O	0	25	70	°C	
2	Supply Voltage	V_{DD}	4.5		14.5	V	
3	Analog Input Voltage	V_{INA}	V_{SS}		3.5	V	
4	Digital Input Voltage	V_{IN}	V_{SS}		V_{DD}	V	

DC Electrical Characteristics† - Voltages are with respect to V_{SS}=0V, V_{DD} =14V unless otherwise stated.

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	Quiescent Supply Current	I_{DDQ}		1	100	µA	All digital inputs at V_{IN}=V_{SS} or V_{DD}
				7	15	mA	All digital inputs at V_{IN}=2.4V
2	Off-state Leakage Current	I_{OFF}			±1	µA	$IV_{Xi} - V_{Yj}I = V_{DD} - V_{SS}$
3	Input Logic “0” level	V_{IL}			0.8	V	
4	Input Logic “1” level	V_{IH}	2.4			V	
5	Input Leakage (digital pins)	I_{LEAK}			10	µA	All digital inputs at V_{IN} = V_{SS} or V_{DD}

† DC Electrical Characteristics are over recommended temperature range & recommended power supply voltages.
‡ Typical figures are at 25°C and are for design aid only; not guaranteed and not subject to production testing.

DC Electrical Characteristics- Switch Resistance - V_{IDC}/V_{ODC} is the external DC offset applied at the analog I/O pins.

	Characteristics	Sym.	25°C		60°C		70°C		Units	Test Conditions
			Typ.	Max.	Typ.	Max.	Typ.	Max.		
1	On-state Resistance V_{DD}=14V	R_{ON}	45	65				75	Ω	V_{SS}=0V, $IV_{Xi}-V_{Yj}I$ = 0.25V V_{IDC}=6.75V V_{ODC}=6.5V
2	Difference in on-state resistance between two switches	ΔR_{ON}	5	10		10		10	Ω	V_{DD}=14V, V_{SS}=0, V_{IDC}=6.75V V_{ODC}=6.5V $IV_{Xi}-V_{Yj}I$ = 0.25V

AC Electrical Characteristics† **- Crosspoint Performance**-V_{DC} is the external DC offset applied at the analog I/O pins. Voltages are with respect to V_{DD}=7V, V_{DC}=0V, V_{SS}=-7V, unless otherwise stated.

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	Switch I/O Capacitance	C_S		20		pF	f=1 MHz
2	Feedthrough Capacitance	C_F		0.2		pF	f=1 MHz
3	Frequency Response Channel “ON” 20LOG(V_{OUT}/V_{Xi})=-3dB	F_{3dB}		45		MHz	Switch is “ON”; V_{INA} = 2Vpp sinewave; R_L = 1kΩ
4	Total Harmonic Distortion	THD		0.05		%	Switch is “ON”; V_{INA} = 2Vpp sinewave f= 1kHz; R_L=1kΩ
5	Feedthrough Channel “OFF” Feed.=20LOG (V_{OUT}/V_{Xi})	FDT		-95		dB	All Switches “OFF”; V_{INA}= 2Vpp sinewave f= 1kHz; R_L= 1kΩ.
6	Crosstalk between any two channels for switches Xi-Yi and Xj-Yj. Xtalk=20LOG (V_{Yj}/V_{Xi}).	X_{talk}		-45		dB	V_{INA}=2Vpp sinewave f= 10MHz; R_L = 75Ω.
				-90		dB	V_{INA}=2Vpp sinewave f= 10kHz; R_L = 600Ω.
				-85		dB	V_{INA}=2Vpp sinewave f= 10kHz; R_L = 1kΩ.
				-80		dB	V_{INA}=2Vpp sinewave f= 1kHz; R_L = 10kΩ.
7	Propagation delay through switch	t_{PS}			50	ns	R_L=1kΩ; C_L=50pF

† Timing is over recommended temperature range.
‡ Typical figures are at 25°C and are for design aid only; not guaranteed and not subject to production testing.
Crosstalk measurements are for Plastic DIPS only, crosstalk values for PLCC packages are approximately 5 dB better.

AC Electrical Characteristics† - Control and I/O Timings- V_{DC} is the external DC offset applied at the analog I/O pins. Voltages are with respect to V_{DD}=7V, V_{DC}=0V, V_{SS}=-7V, unless otherwise stated.

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	Control Input crosstalk to switch (for DATA, STROBE, Address)	CX_{talk}		50		mVpp	V_{IN}=3V+V_{DC} squarewave; R_{IN}=1kΩ, R_L=10kΩ.
2	Digital Input Capacitance	C_{DI}		10		pF	f=1MHz
3	Switching Frequency	F_O			10	MHz	
4	Setup Time DATA to STROBE	t_{DS}	20			ns	R_L= 1kΩ, C_L=50pF
5	Hold Time DATA to STROBE	t_{DH}	20			ns	R_L= 1kΩ, C_L=50pF
6	Setup Time Address to STROBE	t_{AS}	20			ns	R_L= 1kΩ, C_L=50pF
7	Hold Time Address to STROBE	t_{AH}	20			ns	R_L= 1kΩ, C_L=50pF
8	STROBE Pulse Width	t_{SPW}	40			ns	R_L= 1kΩ, C_L=50pF
9	RESET Pulse Width	t_{RPW}	80			ns	R_L= 1kΩ, C_L=50pF
10	STROBE to Switch Status Delay	t_S		80	200	ns	R_L= 1kΩ, C_L=50pF
11	DATA to Switch Status Delay	t_D		100	200	ns	R_L= 1kΩ, C_L=50pF
12	RESET to Switch Status Delay	t_R		70	200	ns	R_L= 1kΩ, C_L=50pF

† Timing is over recommended temperature range.
Digital Input rise time (tr) and fall time (tf) = 10 ns.
‡ Typical figures are at 25°C and are for design aid only; not guaranteed and not subject to production testing.

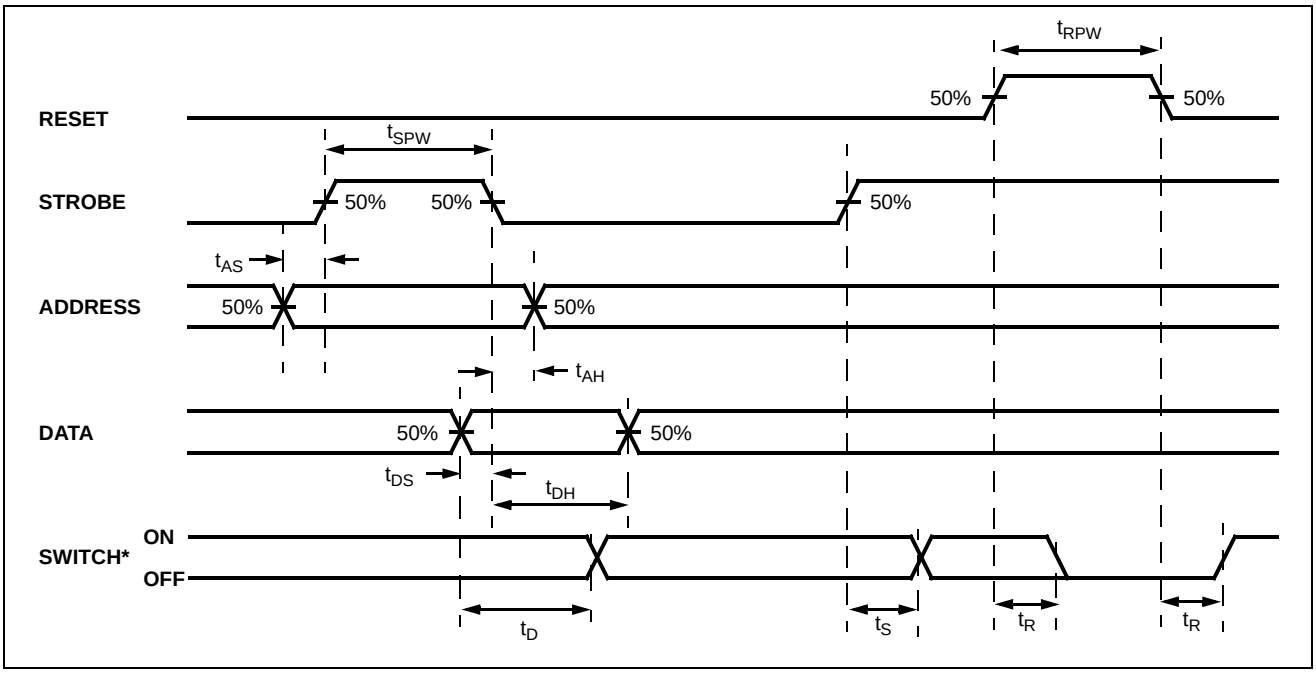
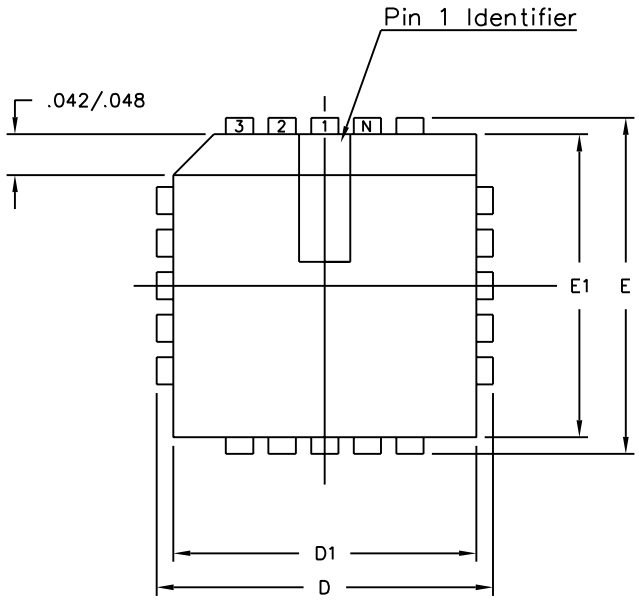


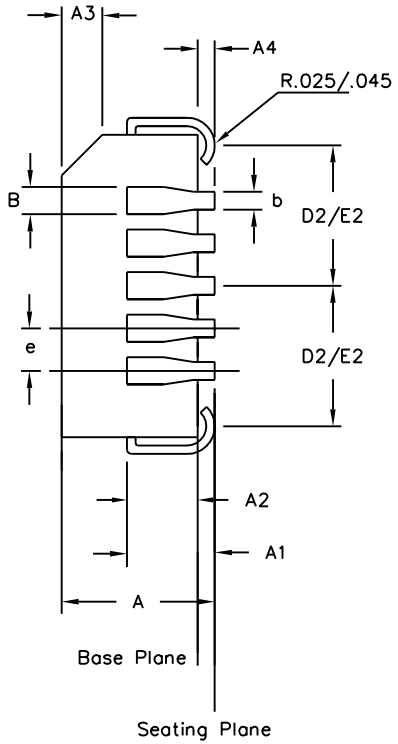
Figure 3 - Control Memory Timing Diagram

AX0	AX1	AX2	AX3	AY0	AY1	AY2	Connection
0	0	0	0	0	0	0	X0-Y0
1	0	0	0	0	0	0	X1-Y0
0	1	0	0	0	0	0	X2-Y0
1	1	0	0	0	0	0	X3-Y0
0	0	1	0	0	0	0	X4-Y0
1	0	1	0	0	0	0	X5-Y0
0	1	1	0	0	0	0	No Connection
1	1	1	0	0	0	0	No Connection
0	0	0	1	0	0	0	X6-Y0
1	0	0	1	0	0	0	X7-Y0
0	1	0	1	0	0	0	X8-Y0
1	1	0	1	0	0	0	X9-Y0
0	0	1	1	0	0	0	X10-Y0
1	0	1	1	0	0	0	X11-Y0
0	1	1	1	0	0	0	No Connection
1	1	1	1	0	0	0	No Connection
0 ↓ 1	0 ↓ 0	0 ↓ 1	0 ↓ 1	1 ↓ 1	0 ↓ 0	0 ↓ 0	X0-Y1 ↓↓ X11-Y1
0 ↓ 1	0 ↓ 0	0 ↓ 1	0 ↓ 1	0 ↓ 0	1 ↓ 1	0 ↓ 0	X0-Y2 ↓↓ X11-Y2
0 ↓ 1	0 ↓ 0	0 ↓ 1	0 ↓ 1	1 ↓ 1	1 ↓ 1	0 ↓ 0	X0-Y3 ↓↓ X11-Y3
0 ↓ 1	0 ↓ 0	0 ↓ 1	0 ↓ 1	0 ↓ 0	0 ↓ 0	1 ↓ 1	X0-Y4 ↓↓ X11-Y4
0 ↓ 1	0 ↓ 0	0 ↓ 1	0 ↓ 1	1 ↓ 1	0 ↓ 0	1 ↓ 1	X0-Y5 ↓↓ X11-Y5
0 ↓ 1	0 ↓ 0	0 ↓ 1	0 ↓ 1	0 ↓ 0	1 ↓ 1	1 ↓ 1	X0-Y6 ↓↓ X11-Y6
0 ↓ 1	0 ↓ 0	0 ↓ 1	0 ↓ 1	1 ↓ 1	1 ↓ 1	1 ↓ 1	X0-Y7 ↓↓ X11-Y7

Table 1 - Address Decode Truth Table

This address has no effect on device status.





Symbol	Control Dimensions in inches		Altern. Dimensions in millimetres	
	MIN	MAX	MIN	MAX
A	0.165	0.180	4.19	4.57
A1	0.090	0.120	2.29	3.05
A2	0.062	0.083	1.57	2.11
A3	0.042	0.056	1.07	1.42
A4	0.020	–	0.51	–
D	0.685	0.695	17.40	17.65
D1	0.650	0.656	16.51	16.66
D2	0.291	0.319	7.39	8.10
E	0.685	0.695	17.40	17.65
E1	0.650	0.656	16.51	16.66
E2	0.291	0.319	7.39	8.10
B	0.026	0.032	0.66	0.81
b	0.013	0.021	0.33	0.53
e	0.050 BSC		1.27 BSC	
	Pin features			
ND	11			
NE	11			
N	44			
Note	Square			
Conforms to JEDEC MS-018AC Iss. A				

Notes:
1. All dimensions and tolerances conform to ANSI Y14.5M–1982
2. Dimensions D1 and E1 do not include mould protrusions. Allowable mould protrusion is 0.010" per side. Dimensions D1 and E1 include mould protrusion mismatch and are determined at the parting line, that is D1 and E1 are measured at the extreme material condition at the upper or lower parting line.
3. Controlling dimensions in Inches.
4. "N" is the number of terminals.
5. Not To Scale
6. Dimension R required for 120° minimum bend.

ISSUE	1	2	3	
ACN	5958	207470	213094	
DATE	15Aug94	10Sep99	15Jul02	
APPRD.				

ZARLINK SEMICONDUCTOR

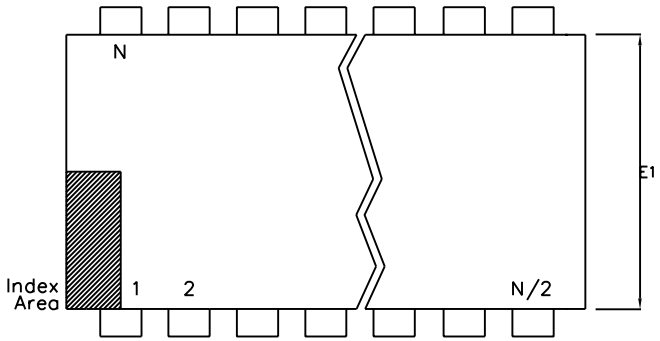
Previous package codes

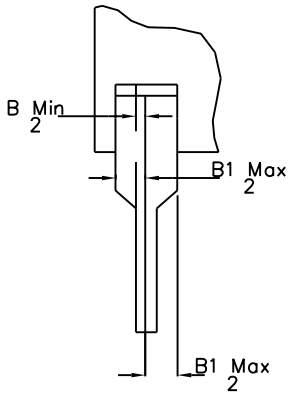
HP / P

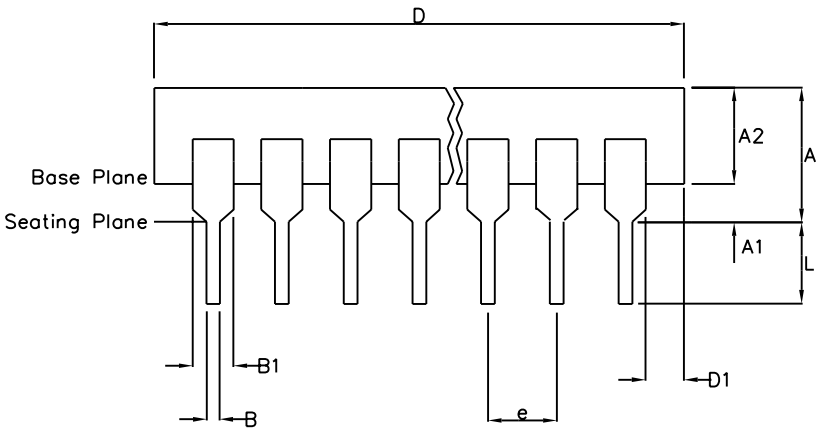
Package Code QA

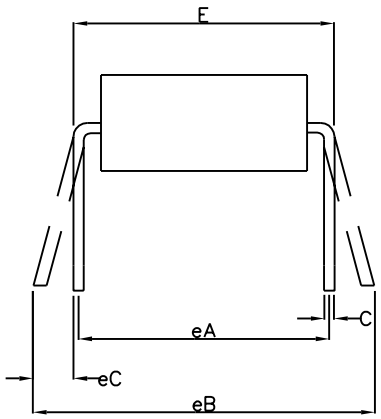
Package Outline for 44 lead PLCC

GPD00003









	Min mm	Max mm	Min Inches	Max Inches
A		6.35		0.250
A1	0.38		0.015	
A2	3.18	4.95	0.125	0.195
B	0.36	0.56	0.014	0.022
B1	0.76	1.78	0.030	0.070
C	0.20	0.38	0.008	0.015
D	50.29	53.21	1.980	2.095
D1	0.13		0.005	
E	15.24	15.88	0.600	0.625
E1	12.32	14.73	0.485	0.580
e	2.54 BSC		0.100 BSC	
eA	15.24 BSC		0.600 BSC	
eB		17.78		0.700
L	2.92	5.08	0.115	0.200
N	40		40	
Conforms to Jedec MS-011AC ISS.B				

Notes:
1. Controlling Dimensions are in inches
2. Dimension A, A1 and L are measured with the package seated in the Seating Plane
3. Dimensions D & E1 do not include mould flash or protrusions. Mould flash or protrusion shall not exceed 0.010 inch.
4. Dimensions E & eA are measured with leads constrained to be perpendicular to plane T.
5. Dimensions eB & eC are measured at the lead tips with the leads unconstrained; eC must be zero or greater.

ISSUE	1	2	3	
ACN	7010	203533	213103	
DATE	20Apr95	25Nov97	15Jul02	
APPRD.				

ZARLINK SEMICONDUCTOR

Previous package codes

DP / E

Package Code DA

Package Outline for 40 lead PDIP

GPD00073

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